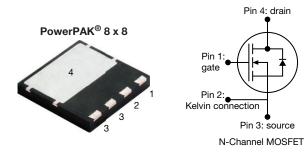
Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



www.vishay.com

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.091				
Q _g max. (nC)	50				
Q _{gs} (nC)	16				
Q _{gd} (nC)	8				
Configuration	Single				

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	PowerPAK 8 x 8			
Lead (Pb)-free and halogen-free	SIHH105N60EF-T1GE3			

ABSOLUTE MAXIMUM RATINGS	$(T_C = 25 \ ^{\circ}C, \text{ unless otherw})$	ise noted)		
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-source voltage	V _{DS}	600	v	
Gate-source voltage	V _{GS}	± 30	v	
Continuous drain current ($T_J = 150 \text{ °C}$)	V_{GS} at 10 V $\frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$		26	
	V_{GS} at 10 V $T_C = 100 \text{ °C}$	I _D	17	А
Pulsed drain current ^a	I _{DM}	59		
Linear derating factor			1.38	W/°C
Single pulse avalanche energy ^b		E _{AS}	127	mJ
Maximum power dissipation		PD	174	W
Operating junction and storage temperature ra	ange	T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	dv/dt	100	V/ns	
Reverse diode dv/dt ^c		50	V/IIS	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega,\,I_{AS}$ = 3.0 A
- c. $I_{SD} \leq I_D, \, di/dt$ = 120 A/µs, starting T_J = 25 $^\circ C$



HALOGEN

FREE



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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R _{thJA}	40	42	°C ///		
Maximum junction-to-case (drain)	R _{thJC}	0.55	0.72	°C/W		

PARAMETER	SYMBOL	ТГО	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
	STNIBUL	TES	T CONDITIONS	IVIIIN.	TTP.	WAX.	UNIT
Static			0.1/1 050 4	600	1	1	- <u> </u>
Drain-source breakdown voltage	V _{DS}		$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		e to 25 °C, I _D = 1 mA	-	0.62	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	-	= V _{GS} , I _D = 250 μΑ	3.0	-	5.0	V
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 20 V$		-	± 100	nA
	-000		$V_{GS} = \pm 30 V$	-	-	± 1	μA
Zero gate voltage drain current	IDSS		= 480 V, V _{GS} = 0 V	-	-	1	P 1
	1055	V _{DS} = 480 V	∕, V _{GS} = 0 V, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 13 A	-	0.091	0.105	Ω
Forward transconductance ^a	g _{fs}	V _{DS}	= 10 V, I _D = 13 A	-	13	-	S
Dynamic							
Input capacitance	C _{iss}		$V_{GS} = 0 V_{V}$	-	2099	-	
Output capacitance	C _{oss}		$V_{DS} = 100 V,$	-	87	-	
Reverse transfer capacitance	C _{rss}		f = 1 MHz	-	5	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	65	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	408	-	1
Total gate charge	Qg	$V_{GS} = 10 \text{ V}$ $I_D = 13 \text{ A}, V_{DS} = 480 \text{ V}$		-	33	50	
Gate-source charge	Q _{gs}			-	16	-	nC
Gate-drain charge	Q _{gd}			-	8	-	1
Turn-on delay time	t _{d(on)}			-	31	62	1
Rise time	t _r	- 	V _{DD} = 480 V, I _D = 13 A,		62	93	
Turn-off delay time	t _{d(off)}	V _{GS} =	= 10 V, R _g = 9.1 Ω	-	38	76	ns
Fall time	t _f			-	28	56	
Gate input resistance	Rg		f = 1 MHz		0.7	1.4	Ω
Drain-Source Body Diode Characteristic				•	•	•	
Continuous source-drain diode current	I _S	showing the	MOSFET symbol showing the		-	26	
Pulsed diode forward current	I _{SM}	p - n junction diode		-	-	59	- A
Diode forward voltage	V _{SD}	T _J = 25 °C	T _J = 25 °C, I _S = 13 A, V _{GS} = 0 V		-	1.2	V
Reverse recovery time	t _{rr}				126	252	ns
Reverse recovery charge	Q _{rr}		5 °C, $I_F = I_S = 13 \text{ A}$,	-	0.6	1.2	μC
Reverse recovery current	I _{BBM}	di/dt = 100 A/µs, V _R = 25 V		-	9.4	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

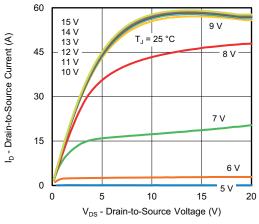


Fig. 1 - Typical Output Characteristics

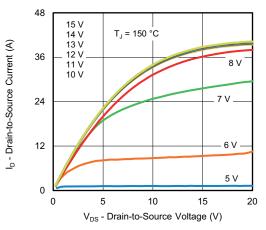


Fig. 2 - Typical Output Characteristics

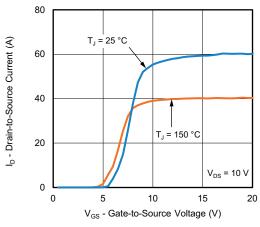


Fig. 3 - Typical Transfer Characteristics

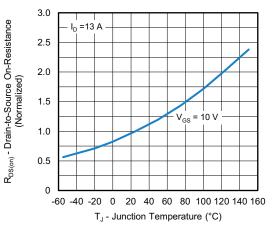


Fig. 4 - Normalized On-Resistance vs. Temperature

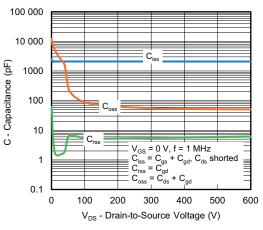
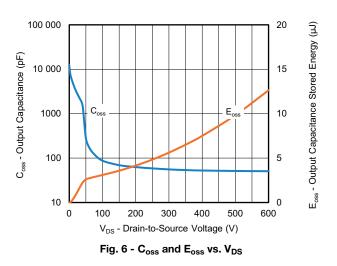


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



S21-0873-Rev. A, 23-Aug-2021

3 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 92415

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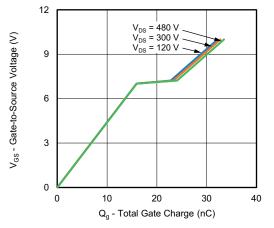


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

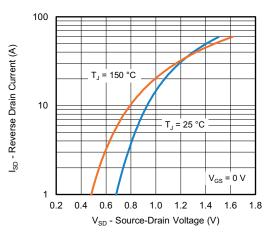


Fig. 8 - Typical Source-Drain Diode Forward Voltage

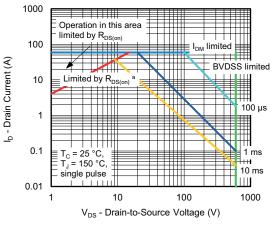


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

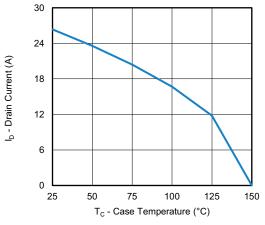


Fig. 10 - Maximum Drain Current vs. Case Temperature

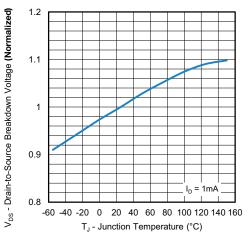
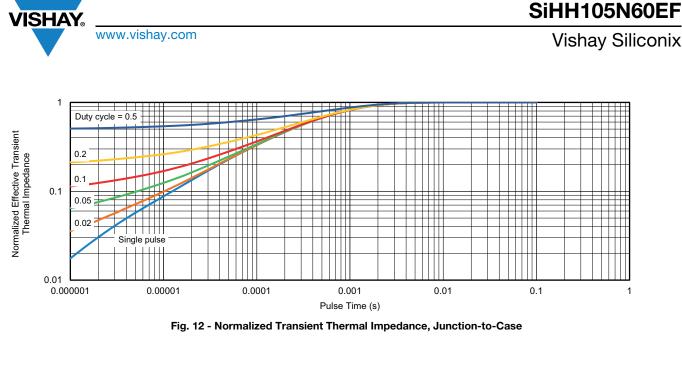


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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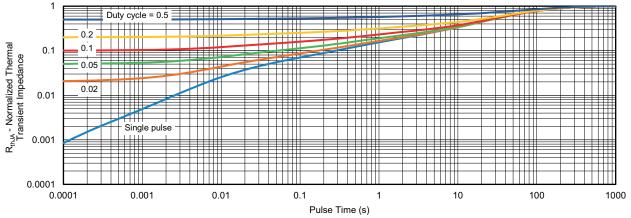


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

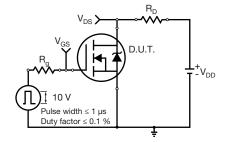


Fig. 14 - Switching Time Test Circuit

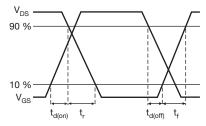


Fig. 15 - Switching Time Waveforms



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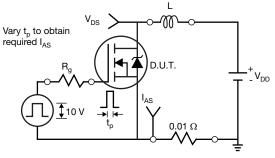


Fig. 16 - Unclamped Inductive Test Circuit

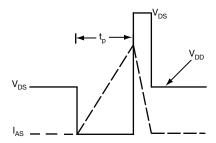


Fig. 17 - Unclamped Inductive Waveforms

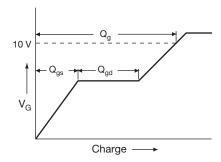


Fig. 18 - Basic Gate Charge Waveform

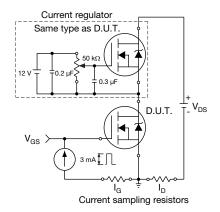


Fig. 19 - Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit

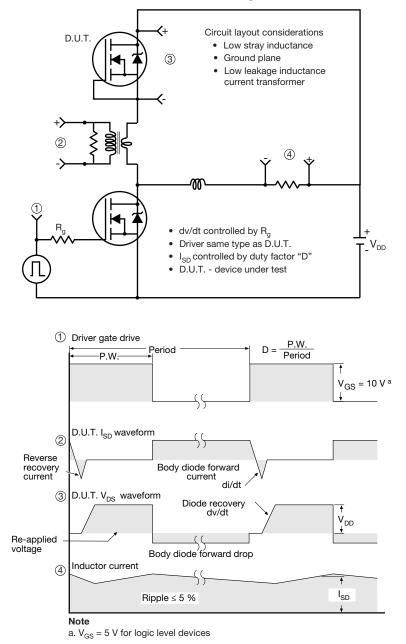


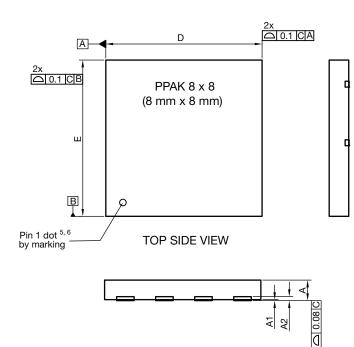
Fig. 20 - For N-Channel

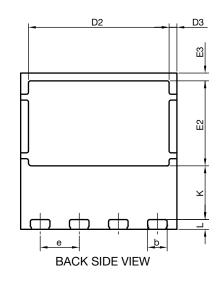
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?92415.



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PowerPAK[®] 8 x 8 Case Outline





DIM	MILLIMETERS		INCHES					
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	0.95	1.00	1.05	0.037	0.039	0.041		
A1	0.00	-	0.05	0.000	-	0.002		
A2	020 ref.			0.008 ref.				
b	0.95	1.00	1.05	0.037	0.039	0.041		
D	7.90	8.00	8.10	0.311	0.315	0.319		
D2	7.10	7.20	7.30	0.280	0.283	0.287		
D3	0.40 BSC			0.016 BSC				
е	2.00 BSC		0.079 BSC					
E	7.90	8.00	8.10	0.311	0.315	0.319		
E2	4.30	4.35	4.40	0.169	0.171	0.173		
E3		0.40 BSC			0.40 BSC 0.016 BSC			
К	2.75 BSC		0.108 BSC					
L	0.45	0.50	0.55	0.018	0.020	0.022		
N ⁽³⁾	8				8			

Notes

⁽¹⁾ Use millimeters as the primary measurement

⁽²⁾ Dimensioning and tolerances conform to ASME Y14.5 M - 1994

⁽³⁾ N is the number of terminals

⁽⁴⁾ The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

⁽⁵⁾ Exact shape and size of this feature is optional

ECN: E20-0518-Rev. B, 28-Sep-2020 DWG: 6041

Revision: 28-Sep-2020

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Recommended Minimum PADs for PowerPAK[®] 8 mm x 8 mm



Dimensions in millimeters

Document Number: 68441



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